

# SERVICE LETTER

DATE: October 28, 1974

NUMBER: DK-3027

SUBJECT: D3000 RETICLE ASSEMBLIES (For Information Only)

PURPOSE: The new process in which the photo diode PCBA's are manufactured has provided enough strength in the solder connection area that the filler (hot melt) has been deleted from the Manufacturing process. Recently ordered reticle assemblies (P/N 103679-01) will be delivered without the white or brown filler covering the photo diode PCBA. This is not a Manufacturing error, but a new process.

Should additional information be required, contact Product Support.

**PERTEC**

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Page 1 of 1  
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